

AE 6020

Anisotropic Electrically Conductive Adhesive

Typical Properties			
Property	Unit	Value	Test Method
Color / Component		Dark Brown	Visual
Particle and Surface		Au on Polymer	EDX
Particle size (um)	Micron	~ 6	SEM
Viscosity at 25°C	cP.s	25,000	ASTM D2196
Thixotropic Index		2.5	ASTM D2196
Density	Gram /cc	1.2	ASTM D792
Weight loss in cure	Weight %	< 0.5 %	TGA
Property as Cured			
Color		Grayish Blue	Visual
Hardness (25 °C)	Shore A	65	ASTM D2240
Contact Resistivity (z direction, 24°C)	Ohm/mm ²	< 0.1	ASTM D257
Volume Resistivity (x, y direction, 24°C)	Ohm-cm	> 10E+12	ASTM D257
Coefficient of Thermal Expansion	ppm/C	< 170 (above Tg) < 80 (below Tg)	IPC-TM-650
Adhesion (Al/Al lap shear)	Psi	> 400	ASTM D1002
Thermal Stability	°C	- 40 to 180	TGA
Cure Profile			
Cure at 150 °C	Second	25	DSC
Cure at 180 °C	Second	6 to 7	DSC
Pot / Work Life at 25°C	Day	> 7	Viscosity double
Shelf Life	Month	6 @ 4°C	ITM

These figures are only intended as a guide and should not be used in preparing specifications.

Characteristics

AE 6020 is a one component, anisotropic, electrically conductive epoxy adhesive designed for replacing anisotropic conductive film (ACF). After a rapid snap-cure at elevated temperatures in seconds with thermo-compression, it forms a flexible bonding film with conducting only in z-direction while remaining insulators in the x,y-plane. This is achieved by a delicate formulation of electrically conductive filler in the adhesive matrix. AE 6020 is designed for LCD, flexible circuit, chip-on-glass, flip chip attachment, and fine pitch assembly. AE 6020 is dispensable and printable.

Special Features and Benefits

- Anisotropic electrical conductivity (z-direction)
- Extremely rapid cure at elevated temperature
- Long pot life in room temperature
- Flexibility to replace tape
- High temperature stability
- Low bleeding, low volatile

Typical Applications

- Flip Chip, TAB Interconnection (ACF, COB, COG, smart card, etc.)
- Lead terminations and connections
- Fine pitch assemblies for electronics
- Flat panel displays, camera modules, mobile phones, and direct access sensors
- Semiconductor packages and RFID tags
- Micro-electronics
- Automotive electronics

Processing Instruction

The z-direction electrical conductivity is based on the contact of the conductive filler with substrate and bump. Heat and pressure are used to trap the conductive particles between bumps and pads of the substrates.

We recommend running preliminary tests to optimize the conditions of heating temperature and compressing pressure for the particular application. Comprehensive processing instructions can be obtained by contacting directly to United Adhesives Inc.

Storage

AE 6020 has a shelf life of at least 6 months when stored below 4 °C in the originally sealed container. The 'Best use before end' date of each batch appears on the product label. Storage beyond the date specified on the label does not necessarily mean that the product is no longer usable. In this case however, the properties required for the intended use must be checked for quality assurance reasons.

Safety information

Comprehensive instructions are given in the corresponding Material Safety Data Sheets. They are available on request from United Adhesives, Inc.

The data presented in this leaflet are in accordance with the present state of our knowledge, but do not absolve the user from carefully checking all supplies immediately on receipt. We reserve the right to alter product constants within the scope of technical progress or new developments. The recommendations made in this leaflet should be checked by preliminary trials because of conditions during processing over which we have no control, especially where other companies' raw materials are also being used. The recommendations do not absolve the user from the obligation of investigating the possibility of infringement of third parties' rights and, if necessary, clarifying the position. Recommendations for use do not constitute a warranty, either express or implied, of the fitness or suitability of the products for a particular purpose. For technical, quality, or product safety questions, please contact directly to United Adhesives Inc.